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# HD151012

# 8-bit Binary Programmable Counter with Synchronous Preset Enable

REJ03D0299-0200Z (Previous ADE-205-132 (Z)) Preliminary Rev.2.00 Jul.16.2004

#### **Description**

The HD151012 has 8-bit binary down counter and D-type Flip Flop. The counter can set up to max 256 counts and synchronous preset (\$\overline{SPE}\$) input can preset the data. When the count value is 0, the next clock pulse presets the data to invert the output. D-type Flip Flop takes the counter output as clock pulse, whose data is transferred to output at the rise edge. It is applied to generate AC signal for STN type liquid crystal and general-use divider.

#### **Features**

- High speed operation tpd (CLK or  $\overline{\text{CLK}}$  to Q) = 35 ns (typ)
- High output current Fanout of 10 LS TTL Loads
- Wide operating voltage  $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low supply current (Ta = 25°C)  $I_{CC}$  (Static) =  $4 \mu A$  (max)
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD151012TELL	TSSOP-16 pin	TTP-16DAV	Т	ELL (2,000 pcs/reel)

#### **Function Table**

Control Inputs							
CLR	PR	SPE	Mode	Operation Description			
Н	Н	Н	Generally count	Down count at the rise edge of clock (CLK)			
				Down count at the fall edge of clock (CLK)			
Х	Х	L	Synchronous preset	Jn data is preset at the rise of clock (CLK), the fall of clock (CLK)			
L	Н	_	Initialize of Q output	Initialize of Q = "L"			
Н	L	_	Initialize of Q output	Initialize of Q = "H"			

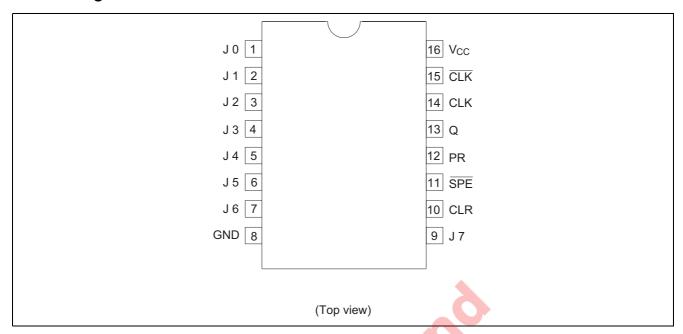
Notes: 1. Synchronous preset (SPE) input can set max 256 down counts.

- 2. When the count value is 0, the next clock pulse presets the data to invert the output.
- 3. CLR and PR inputs initialize output state.

H: High levelL: Low levelX: Immaterial

— : Irrespective of condition

#### **Pin Arrangement**



## **Pin Description**

Pin Name		Pin Description					
Input pins	J0 to J7	Count data input for option					
	CLK, CLK	Clock inputs CLK : Rise edge trigger					
		CLK: Fall edge trigger					
	SPE	Preset input for Jn data					
	PR	Preset input for D-type Flip Flop (Initialize "L" at Q output)					
	CLR	Clear input for D-type Flip Flop (Initialize "H" at Q output)					
Output pins	Q	Output for D-type Flip Flop					

## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage	V <sub>cc</sub>	-0.5 to 7.0	V
Input / output voltage	V <sub>IN</sub> /V <sub>OUT</sub>	$-0.5$ to $V_{CC}$ +0.5	V
VCC, GND current	I <sub>cc</sub> , IGND	±50	mA
Output current / pin	I <sub>OUT</sub>	±25	mA
Power dissipation	$P_T$	500	mW
Storage temperature	Tstg	-65 to 150	$\circ$
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	I <sub>ok</sub>	±20	mA

Notes: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

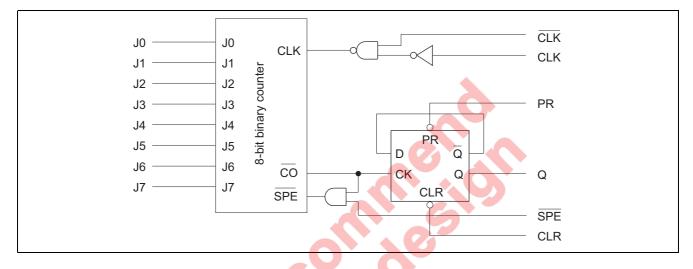
2. All voltage values except for differential input voltage are with respect to network ground terminal.

## **Recommended Operating Conditions**

Item	Symbol	Min	Тур	Max	Unit	
Supply voltage	V <sub>CC</sub>	2	_	6	V	
Input/output voltage		$V_{IN}/_{OUT}$	0	_	$V_{CC}$	V
Operating temperature		Topr	-40	_	+85	$_{\mathbb{C}}$
Input rise/fall time*1	$V_{CC} = 2.5 \text{ V}$	t <sub>r</sub> , t <sub>f</sub>	0	_	1000	ns
	V <sub>CC</sub> = 4.5 V		0	_	500	
	$V_{CC} = 5.5 \text{ V}$		0	_	400	

Note: 1. This item guarantees maximum limit when one input switches.

## **Logic Diagram**



#### **Electrical Characteristics**

			T- 0500			Ta = –40 to 85℃				
Item Symbo		\ <u>\</u>	Ta = 25 °C Min Typ Max		−40 to	Max	Unit	Test Conditions		
High level input		<b>V</b> <sub>cc</sub> 2.0	1.5	тур	wax	1.5	wax	V	J0 to J7	Conditions
•	V <sub>IH</sub>	4.5				3.15	_	- V	SPE	
voltage			3.15			4.2			PR, CLR	
		6.0	4.2	_	_				CLK, CLK	
		2.0	1.5	_	_	1.5			CLK, CLK	
		4.5	3.15			3.15		1		
	\ /	6.0	4.2			4.2	_	V	10 +- 17	
_ow level input	V <sub>IL</sub>	2.0			0.5		0.5	V	J0 to J7	
oltage/		4.5			1.35		1.35		SPE	
		6.0	_	_	1.8	_	1.8	1	PR, CLR	
		2.0	_	_	0.5		0.5	4	CLK, CLK	
		4.5	_	_	1.35	_	1.35	1		
		6.0	_	_	1.8	_	1.8			T
High level output	$V_{OH}$	2.0	1.9	2.0	_	1.9		V	$V_{IN} =$	$I_{OH} = -20 \text{ mA}$
oltage/		4.5	4.4	4.5	_	4.4	_		$V_{IH}$ or $V_{IL}$	
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	4.31	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	5.80	_	5.63				$I_{OH} = -5.2 \text{ mA}$
Low level output	$V_{OL}$	2.0	_	0.0	0.1	_	0.1	V	V <sub>IN</sub> =	$I_{OL} = 20 \text{ mA}$
voltage		4.5	_	0.0	0.1		0.1		V <sub>IH</sub> or V <sub>IL</sub>	
		6.0	_	0.0	0.1	<b>-</b>	0.1			
		4.5	_	0.17	0.26		0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	0.18	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
nput capacitance	I <sub>IN</sub>	6.0	_	-	±0.1	_	±1.0	mA	$V_{IN} = V_{CC}$ or GNE	)
Supply current	I <sub>CC</sub>	6.0			4.0	_	40.0	mA	$V_{IN} = V_{CC}$ or GNE	)

## Switching Characteristics ( $C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns}$ )

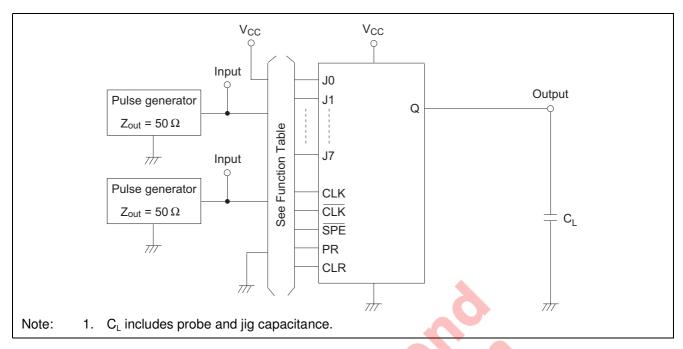
					Ta =				
	Sym-		Ta = 25 ℃		–40 to	85°C			
Item	bol	V <sub>cc</sub>	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	$f_{max}$	2.0	_	_	4	_	3	MHz	
frequency		4.5	_	36	20	_	16		
		6.0	_	—	24	_	19		
Output rise/fall time	$t_{TLH}$	2.0	_	30	75	_	95	ns	
	$t_{THL}$	4.5	_	8	15	_	19		
		6.0	_	7	13	_	16		
Propagation delay	t <sub>PLH</sub>	2.0	_		300	_	380		CLK or CLK to Q
time	$t_{PHL}$	4.5	_	35	60	_	75		
		6.0	_	_	53	_	65		
	$t_{PLH}$	2.0	_	_	150	_	185		PR or CLR to Q
	$t_{PHL}$	4.5	_	18	30	_	38		
		6.0	_	_	25	_	32		
Pulse width	tw	2.0	80	_	_	100	_	ns	
(CLK, CLK, PR, CLR)		4.5	16	_	_	20	_		
		6.0	14	_	_	17	_		
Setup time	ts	2.0	100	_	_	125	_	ns	
(Jn - CLK, CLK)		4.5	20	_	_	25	(	1	
(SPE, CLK, CLK)		6.0	17	_	_	21	1		
Hold time	th	2.0	15	_	_	15	4	ns	
(Jn - CLK, CLK)		4.5	10	_	_	10			
(SPE, CLK, CLK)		6.0	5	_	- •	5	_	1	,
Input capacitance	C <sub>IN</sub>	_	_	5	10		10	pF	
Power dissipation capacitance*1	C <sub>PD</sub>			48	5	_	0	pF	

Note: 1. CPD is equivalent capacitance inside of the IC calculated from the operating current without load (see test circuit). The average operating current without load is calculated according to the expression below.

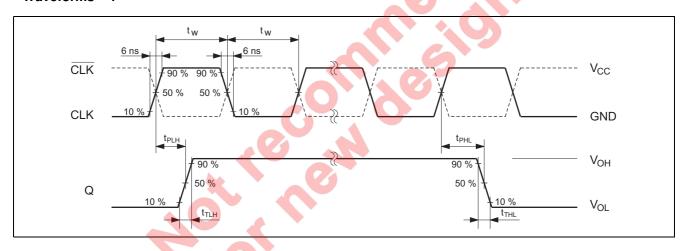
I<sub>CC</sub> (opr) = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>IN</sub> + I<sub>CC</sub>



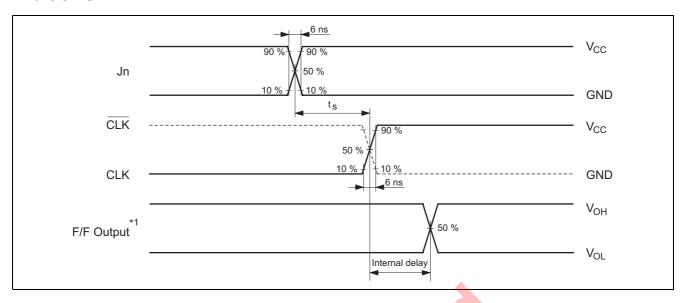
#### **Test Circuit**



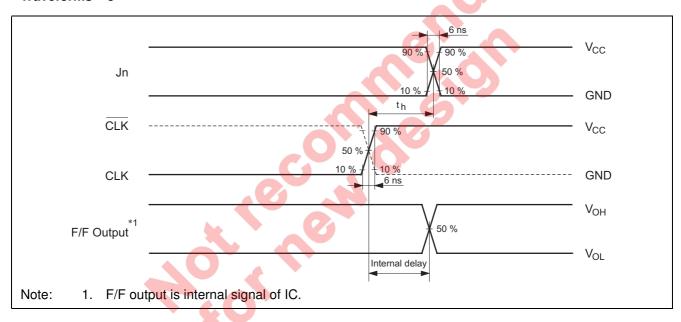
#### Waveforms - 1



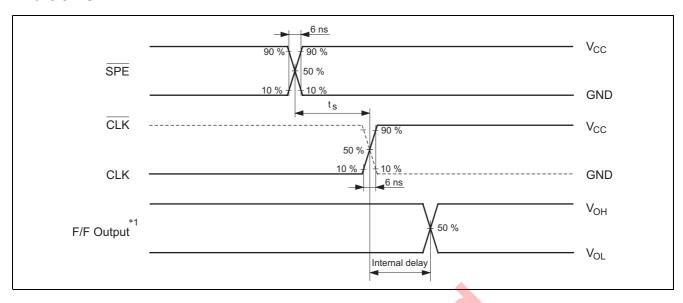
#### Waveforms - 2



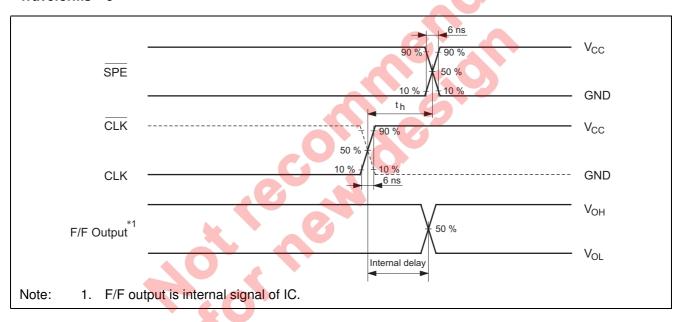
#### Waveforms - 3



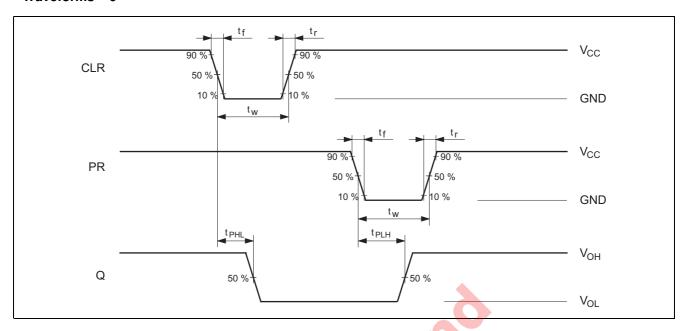
#### Waveforms - 4



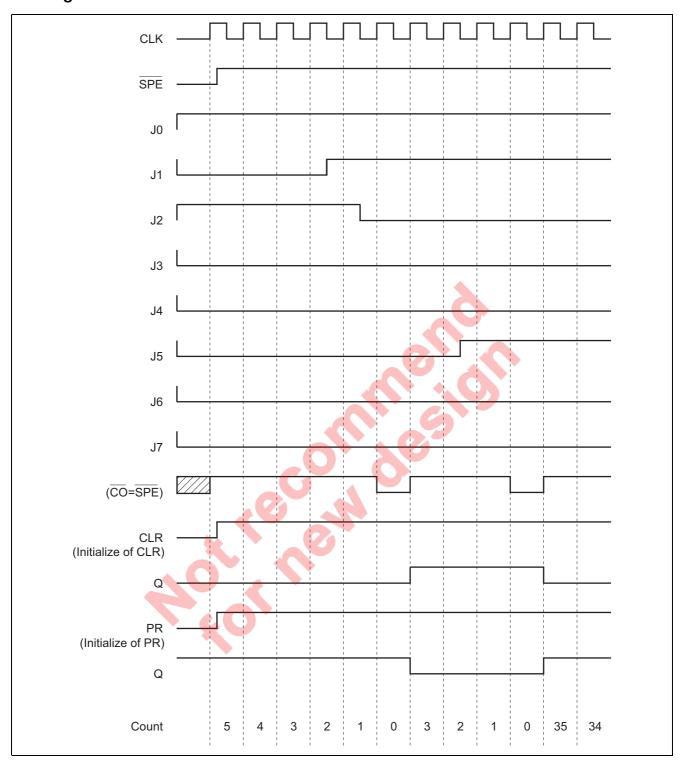
#### Waveforms - 5



#### Waveforms - 6

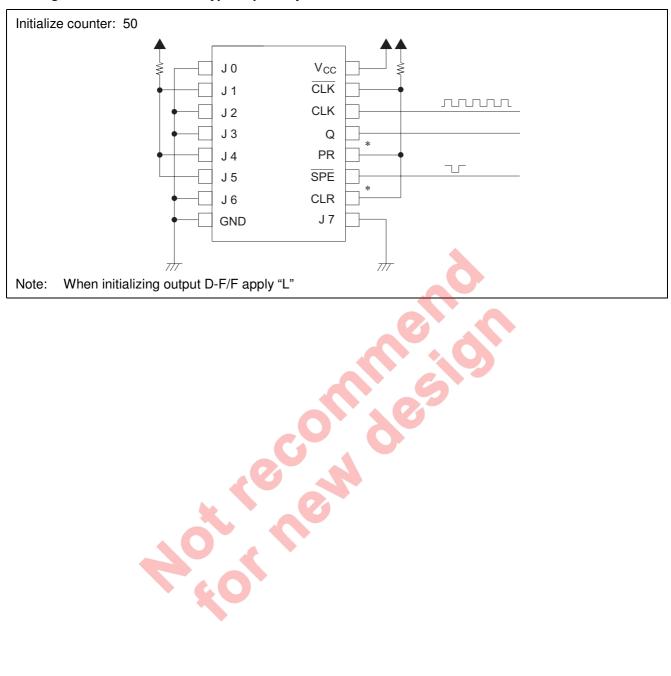


## **Timing Chart**



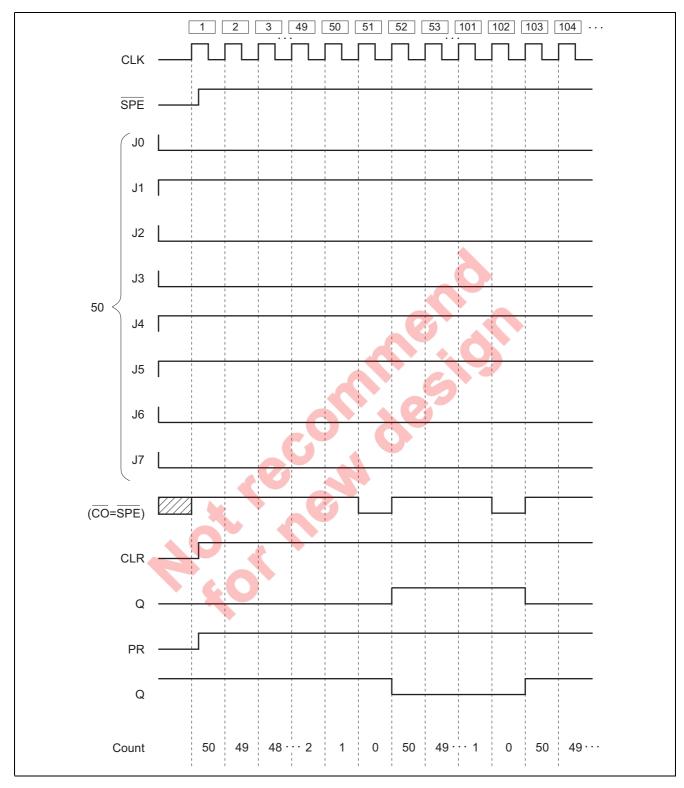
## **Example of Application Circuit**

#### **AC Signal Generator for STN Type Liquid Crystal Panel**

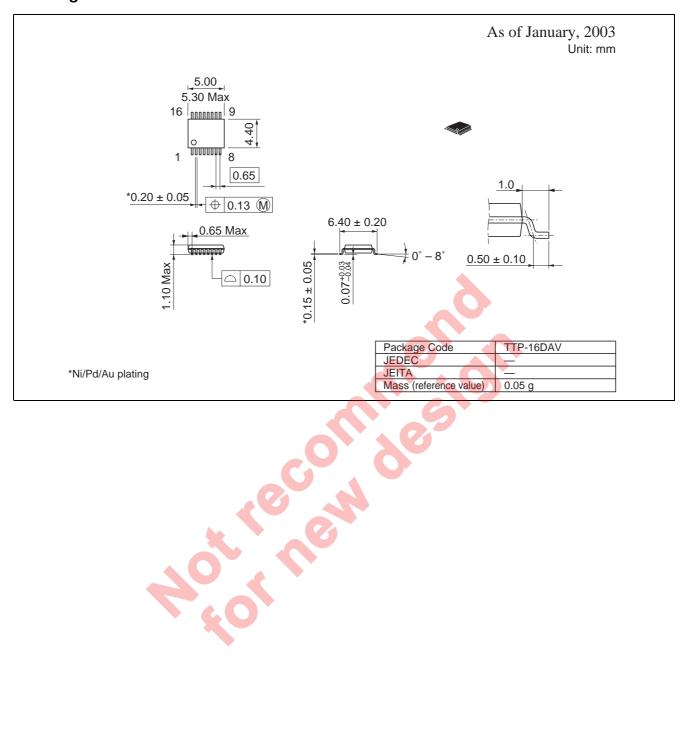


## **Timing Chart**

### **Example of AC Signal Generator**



#### **Package Dimensions**



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